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Formaldehyde Emissions from Low Emitting Pressed-Wood Products and the Effectiveness of Various Remedial Measures for Reducing Formaldehyde Emissions

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Abstract

This report presents the results of chamber tests to determine the emission of formaldehyde from several low emitting US and foreign manufactured particle boards and the effectiveness of various remedial actions on the emission of formaldehyde from pressed wood products. Pressed wood products considered to represent the most recent (as of the fall of 1985) US and foreign manufacturing technology were obtained from seven US manufacturers and six European manufacturers representing four countries. Most of the pressed wood products tested were underlayment (29) and low emitting medium density fiber board (8). Two (2) industrial particle boards were tested. The technologies identified by the product's manufacturer used to reduce the emissions of formaldehyde were 1.) low furning UF resins, 2.) low furning UF resins with a post press scavenger (usually anhydrous ammonia) and 3.) the addition of a chemical additive. The remedial measures evaluated consisted of the application of coatings and barriers. The coatings tested for their effectiveness in reducing formaldehyde emissions were polyurethane, nitrocellulose lacquer and latex paint. The barriers evaluated were carpeting with foam padding and carpeting with waffle padding.

1 Introduction

The National Bureau of Standards (NBS) has recently [1] undertaken a series of laboratory tests for the Consumer Product Safety Commission (CPSC) to validate models used to predict formaldehyde (HCHO) emissions from pressed wood products. These tests have shown that for bare pressed wood products there is good agreement between IAQ models and measurements in a simulated house. However, a person is not often exposed directly to the emission from a pressed wood product. For example, when particle board underlayment is used as a flooring material, it is usually covered with tile or a carpet and padding. Another example could be a kitchen cabinet made with medium density fiberboard (MDF) where the MDF is usually finished with a coating or covered with another material.

Also, there have been new developments in the manufacture of pressed wood products which reportedly have lead to a reduced emission of formaldehyde. For this reason NBS with the assistance of the US Environmental Protection Agency (EPA) received from both US and foreign manufacturers samples of their lowest emitting pressed wood products. A total of 12 foreign boards and 33 recently manufactured US boards were obtained. Previously, CPSC had obtained for NBS 6 samples of low emitting medium density fiber board (MDF). These products were evaluated in specially designed medium size dynamic chambers (see ref. [1] for details on the construction, operation and test procedures used to determine HCHO emissions in dynamic chambers) to obtain their emission rates as a function of formaldehyde level at the standard conditions of 23 °C, 50% relative humidity. Several products (underlayment, industrial particle board and low emitting MDF) were coated with polyurethane, nitrocellulose lacquer and latex paint to determine the effect of these coatings on their formaldehyde emissions. The effect of padding and carpeting on the emission of formaldehyde from underlayment was also investigated.

2 Brief Summary of the Model

As discussed in reference [1], the emission rate ER (in mg/m²•h) of HCHO from a pressed wood product can be predicted from the equation:

$$ER = \alpha - \beta c \tag{1}$$

where α and β are parameters which can be determined from laboratory measurements in the medium size dynamic chambers and c is the concentration of HCHO in the chamber (in ppb). In general α and β are functions of temperature and humidity. In this report the intercept α and the cutoff concentration at which the emission rate goes to zero:

$$cutoff = \frac{\alpha}{\beta}$$
(2)

are reported for each product. The determination of these two parameters allows the prediction of HCHO levels in buildings under various loadings and air exchange rates using a mass balance model (see reference [1]).

In the tables and graphs in this report, values for α (call the intercept) and the cutoff are reported as well as ser₁₀₀, the emission rate at standard conditions (23°C, 50% RH and an ambient concentration c = 100 ppb) and the correlation coefficient R^2 and the standard error of a least squares fit of equation (1) to the chamber data for each product tested. The use of these parameters for predicting the HCHO levels in buildings due to emissions from pressed wood products is summarized in the appendix of this report.

3 Summary of Previous Data from Test for CPSC

For completeness, data from the tests performed for CPSC in the research to validate models for predicting formaldehyde levels in homes are included in this report (see references [1] and [2] for a more complete discussion of these data). Table 1 contains the results of the determination of HCHO emissions from underlayment at 23°C, 50% RH. Table 2 contains the results of similar measurements at 26°C, 60% RH. It should be noted in Table 1 that tests indicated by T1 and T2 were performed prior to subjecting the boards to the higher temperature and humidity. The boards used in the CPSC tests were manufactured at one facility in June of 1984. The tests indicated by T3 and T4 were at the higher temperature and humidity conditions. The tests indicated by T5 occurred after returning the specimens to the conditions of the test T1 and T2. The data in Table 2 show that at a temperature of 26°C and 60% RH, the emissions of formaldehyde from these products at 100 ppb (ser₁₀₀) occurred at rates greater than three times the rate at 23°C, 50% RH. This increase in temperature and humidity alos caused the cutoff concentrations to increase by more than 50%. It is also worthy of note that the emission rates of test T5 were all higher than those of tests T1 and T2 for all products.

4 The Effects of Carpets and Padding on Formaldehyde Emissions

Seven particle board underlayments were selected for an experiment to determine the effect of carpets and padding on the emission of HCHO from underlayment. The carpets and padding were initially tested in the medium size chambers in order to determine if they by themselves emitted any significant level of formaldehyde. It was found that they did not. Four underlayments were covered with carpet and padding in May 1986. Two boards were covered with foam padding and carpet, two with waffle padding and carpet and three were left uncovered to serve as controls. After four months, the emission rates of formaldehyde from the composite of underlayment, padding and carpet were measured in the medium size chambers. The results of these tests are summarized in Table 3. Also included in Table 3 are the results of covering underlayment U5 of the CPSC tests with a carpeting and a foam padding. As can be seen from the data of Table 3, the composite of foam padding and carpet had little effect on the emission rate of formaldehyde from the underlayment. However, the composite with carpet and waffle padding reduced the HCHO emission of the underlayment to approximately 30% of the control underlayment.

5 The Effectiveness of Coatings in Reducing Formaldehyde Emissions

In order to test the effectiveness of various paint-like coatings for reducing HCHO emissions from pressed wood products, several specimens of underlayment, industrial particle board and low emitting medium density fiber board were coated with latex paint, nitrocellulose lacquer and a polyurethane finish. Samples of the underlayment, industrial particle board and low emitting MDF were first evaluated without any coating. Some were then coated with latex paint, nitrocellulose lacquer and polyurethane and retested. The results of this test sequence are shown inf Figures 1 to 12 and summarized in Tables 6, 7, 8 and 10. Also included in Table 6 are the results of testing two underlayments received from Ball State University, one of which had an unknown coating. These results of these tests showed that nitrocellulose lacquer reduced the emission rate of formaldehyde to 69% of the precoated value for underlayment, 53% for industrial particle board and 26% for low emitting medium density fiber board. Polyurethane reduced the emission rate of underlayment to 18% of the precoated value and to 6% for the low emitting medium density fiberboard. The polyurethane and latex coated industrial particle board showed increases of 140% and 150% respectively. The latex coating had little or no effect on the emission rates of underlayment and medium density fiberboard (95% and 90% respectively).

6 The Emission Rates of Low Emitting Medium Density FiberBoard

Figure 9 and Table 5 contain the results of testing five specimens of regular MDF manufactured in the United States. From the data of Table 5 regular MDF emits formaldehyde at rates of 0.995 to 1.549 mg/m²-h. These data compare favorably with the data of reference [1] (1.36 mg/m²-h). The untreated emission rate from low emitting MDF are given in Table 8. These range from 0.429 to 0.668 mg/²-h, approximately half those of regular MDF, though still high compared with underlayment.

7 Summary of New Technology US Manufactured Particle Boards

Thirty-one (31) particle boards were received from seven US manufacturers in response to a request by EPA to provide two samples of low emitting pressed wood products. These were classified by the manufacturers as having 1.) low fuming UF resin, 2.) low fuming UF resin with a scavenger 3.) low fuming resin industrial particle board and 4.) underlayment with a chemical additive. Two boards from one manufacturer contained no information on the remedial measures used in the manufacture of the boards. The data from these products are given in Table 4 and Figures 13 and 14. The boards with low fuming resin have emissions rate ranging from 0.052 to 0.367 mg/m²•h, with five boards from two manufacturers having emission rates less then 0.1 mg/m²•h. The emission rates of products with low fuming resins and a scavenger ranged from 0.102 to 0.254 mg/m²•h.

8 Emissions from Foreign Particle Boards

Twelve particle boards were received from six manufacturers in four European countries. The results of the evaluation of these products are shown in Table 9 and Figures 15 through 20. Products of three countries, France, Sweden and Belgium, had very low emission rates (0.012 to 0.112 mg/m²•h). These boards also have very low cutoff concentrations (less than 150 ppb). The boards for Norway had relatively low cutoff concentrations (less than 317 ppb) but showed a sharp increase in emission rate as a function of ambient concentration (see Figures 14 and 15).

9 Conclusions

The data from this series of experiments have shown that various measures can be effective in reducing the emission of formaldehyde from pressed wood products

- •Carpets with waffle padding can reduce HCHO emissions from underlayment by 60%
- •Polyurethane coating can reduce HCHO emissions by 80% on underlayment and low emitting MDF
- •Nitrocellulose lacquer can reduce HCHO emissions by 30% for underlayment, 75% for low emitting MDF and 50% for industrial particle board.
- •Swedish, French and Belgium manufactured boards tested in this project can have emission rates less than 0.1 mg/m²•h and cutoff concentrations less than 125 ppb.
- •Some US manufactured particle boards have characteristics approaching the best European boards.

On the negative side, there were several measures which were not effective in reducing HCHO emissions. Latex paints (as expected) do not decrease HCHO emission from pressed wood products. Coatings can have a varying effect depending on the product coated. Foam padding did not decreased HCHO emissions from underlayment. Some supposedly low emitting pressed wood products still have significant emission rates

References

- Grot, R.A., S. Silberstein, K. Ishiguro, "Validation of Models for Predicting Formaldehyde Concentrations in Residences Due to Pressed Wood Products, Phase I", NBSIR 85-3255, Gaithersburg, MD, 1985
- [2] Silberstein, S., R.A. Grot, "Validation of Models for Predicting Formaldehyde Concentrations in Residences Due to Pressed Wood Products, Phase II", NBSIR 88-XXXX, Gaithersburg, MD, in preparation.

Appendix

A Model for Predicting HCHO Levels in a Single Zone Building Using Chamber Data

As shown and verified in references [1,2], the following model, derived using mass balance principles, can adequately predict the equilibrium level C_{o} of HCHO in a single zone, well mixed building:

$$C_o = \frac{\hat{\alpha}}{Ai + \hat{\beta}} \tag{A1}$$

where

$$\hat{\alpha} = \frac{1}{\rho V} \sum_{\forall products} \alpha_i \cdot area_i$$
(A2)

$$\hat{\beta} = \frac{1}{\rho V} \sum_{\forall products} \beta_i \cdot area_i \tag{A3}$$

where

Ai is the air change rate in h-1

area, is the exposed area of the pressed wood product in m^2

and

 α_i and β_i are the parameters of equation (1) determined from the chamber tests.

 $\rho = 0.0012 \text{ mg/cm}^3$ (density of formaldehyde)

V is the volume of the building in m^3

The concentration determined from equation (A1) is in ppb.

Tables A.1 and A.2 contain the predicted concentrations for a house maintained at 23°C, 50% RH completely floored with US and foreign pressed wood products. These predicted results are shown in Figures 21 to 32.

Table 1. Underlayment Obtained for CPSC Tests

23°C 50% RH

Board #	Date	intercept	cutoff	R²	ser ₁₀₀	Std. error
		mg/m²•h	ppb		mg/m²•h	mg/m²•h
U1-T1 U1-T2 U1-T5 U2-T1 U2-T2 U2-T5 U3-T5 U4-T1 U4-T2 U4-T5 U5-T1 U5-T2 U5-T5 U6-T1 U6-T2 U6-T5 U7-T1 U7-T2 U7-T5 U7-T5	10/01/84-11/16/84 02/09/85-02/14/85 04/18/86-04/28/86 11/10/84-11/13/84 02/20/85-02/26/85 04/09/86-04/18/86 03/07/86-03/19/86 09/28/84-11/14/84 03/01/85-03/05/85 04/18/86-04/28/86 10/01/84-11/12/84 02/15/85-02/20/85 03/07/86-03/19/86 11/16/84-02/08/85 03/28/85-04/02/85 03/07/86-03/19/86	$\begin{array}{c} 0.209\\ 0.237\\ 0.310\\ 0.328\\ 0.211\\ 0.242\\ 0.250\\ 0.213\\ 0.213\\ 0.213\\ 0.276\\ 0.160\\ 0.168\\ 0.234\\ 0.266\\ 0.211\\ 0.262\\ 0.243\\ 0.232\\ 0.262\\ 0.243\\ 0.232\\ 0.262\\ 0.$	205 241 393 268 270 313 324 261 277 359 260 283 337 222 262 345 274 266 308	0.912 0.914 0.994 0.994 0.789 0.895 0.371 0.866 0.969 0.724 0.883 0.901 0.993 0.985 0.974 0.813 0.813 0.913	0.107 0.138 0.231 0.205 0.133 0.165 0.173 0.131 0.136 0.199 0.099 0.099 0.109 0.109 0.164 0.146 0.130 0.186 0.154 0.145 0.177	$\begin{array}{c} 0.020\\ 0.029\\ 0.009\\ 0.014\\ 0.025\\ 0.008\\ 0.029\\ 0.062\\ 0.026\\ 0.018\\ 0.025\\ 0.018\\ 0.025\\ 0.018\\ 0.019\\ 0.012\\ 0.009\\ 0.015\\ 0.027\\ 0.039\\ 0.026\end{array}$
07-10	10/22/00-10/20/00	0.102	212	0.9/3	0.085	0.012

Table 2. Underlayment Obtained for CPSC Tests

26°C 60% RH

	cuton	K-	Ser ₁₀₀	Std. error
mg/m²•h	ppb		mg/m²•h	mg/m²•h
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	395 404 412 413 433 408 383 436 484 880 467	0.933 0.976 0.880 0.885 0.830 0.882 0.999 0.903 0.972 0.492	0.281 0.499 0.327 0.317 0.351 0.275 0.316 0.377 0.342 0.342 0.342	0.038 0.040 0.057 0.051 0.077 0.048 0.007 0.067 0.026 0.096
	mg/m ² •h 5 0.377 5 0.663 5 0.432 5 0.418 5 0.457 5 0.365 5 0.428 5 0.428 5 0.431 35 0.386 35 0.319	mg/m²•h ppb 5 0.377 395 5 0.663 404 5 0.432 412 5 0.418 413 5 0.457 433 5 0.365 408 5 0.428 383 5 0.428 383 5 0.431 484 35 0.386 880 35 0.319 467	mg/m²-h ppb 5 0.377 395 0.933 5 0.663 404 0.976 5 0.432 412 0.880 5 0.432 413 0.885 5 0.457 433 0.830 5 0.457 433 0.830 5 0.457 433 0.830 5 0.457 433 0.830 5 0.457 433 0.830 5 0.457 433 0.830 5 0.457 433 0.842 5 0.428 383 0.999 35 0.431 484 0.972 35 0.386 880 0.492 35 0.319 467 1.000	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

Note:

U1 to U7 indicate underlayment specimens 1 through 7 T1 to T4 indicate test

Table 3. Emissions from Carpeted Underlayment

Carpet with Foam Padding

Board #	Date	intercept	cutoff	R²	Ser ₁₀₀	Std. error
C1 C2 U5-T2C	11/06/86-11/24/86 11/06/86-11/24/86 03/28/85-04/02/85	mg/m²•h 0.206 0.188 0.161	ppb 263 382 256	0.874 0.930 0.798	mg/m²•h 0.128 0.139 0.098	mg/m²•h 0.031 0.020 0.030
	C	arpet with Wa	ffle Paddin	g		
Board #	Date	intercept	cutoff	R²	$ser_{i\infty}$	Std. error
C3 C4	11/06/86-11/24/86 11/06/86-11/24/86	mg/m²•h 0.112 0.118	ppb 180 216	0.856 0.927	mg/m⊶h 0.050 0.064	mg/m²•h 0.019 0.014

Untreated Control Underlayment for Carpets

Board #	Date	intercept	cutoff	R²	ser ₁₀₀	Std. error
		mg/m²•h	ppb		mg/m²•h	mg/m²•h
C5 C6 C7	10/22/86-10/30/86 10/22/86-10/30/86 10/22/86-10/30/86	0.310 0.232 0.196	369 365 347	0.995 0.985 0.971	0.226 0.169 0.140	0.009 0.012 0.015

Note:

C1 through C7 indicated underlayment boards used in carpet experiment. U5-T2C is carpet covered underlayment U5 of Table 1

Board #	Date	intercept	cutoff	R²	Ser ₁₀₀	Std. error
		mg/m²•h	ppb		mg/m²•h	mg/m²•h
	U	Jnknown Classi	fication			
USM1-1A USM1-1B	01/13/87-01/30/87 01/13/87-01/30/87 Low Furning	0.287 0.276 UF Resin Indus	334 350 strial Partic	0.858 0.913 cle Board	0.201 0.197	0.038 0.030
USM2-1A USM2-1B	05/01/86-06/11/86 05/01/86-06/11/86 Low Fu:	0.316 0.230 ming UF Resin	649 582 and Scave	0.669 0.675 nger	0.268 0.191	0.075 0.053
USM3-1A USM3-1B USM3-2A USM3-2B USM3-3A USM3-3B USM4-1A USM4-1B USM5-1A USM5-1B	04/08/86-05/13/86 04/08/86-05/13/86 06/15/87-06/26/87 05/15/87-05/29/87 04/08/86-05/13/86 04/08/86-05/13/86 04/08/86-05/13/86 04/08/86-05/13/86 06/01/87-06/15/87 05/15/87-05/29/87	0.171 0.173 0.254 0.160 0.274 0.238 0.187 0.197 0.331 0.184 Low Fuming UF	973 597 342 391 347 379 634 576 431 226 5 Resin	0.224 0.786 0.943 0.942 0.969 0.778 0.763 0.977 0.989 0.986	0.153 0.144 0.180 0.119 0.195 0.175 0.158 0.162 0.254 0.102	0.061 0.030 0.022 0.013 0.016 0.031 0.034 0.010 0.014 0.007
USM2-2A USM2-2B USM2-3A USM2-3B USM6-1A USM6-1B USM6-2A USM6-2B USM6-3A USM6-3B USM7-1A USM7-1B USM7-1C	05/27/86-08/10/86 05/27/86-08/10/86 05/01/86-06/11/86 03/30/87-04/18/87 03/30/87-04/18/87 03/19/86-04/07/86 03/19/86-04/07/86 12/20/86-01/12/87 01/13/86-01/30/87 01/09/87-02/06/87 01/09/87-02/06/87	0.156 0.178 0.150 0.270 0.211 0.183 0.182 0.200 0.298 0.288 0.128 0.116 0.097 Chemical Add	386 403 646 582 180 185 383 487 295 365 312 208 215 itive	0.419 0.524 0.469 0.806 0.974 0.978 0.322 0.264 0.937 0.946 0.923 0.979 0.939	$\begin{array}{c} 0.115\\ 0.134\\ 0.127\\ 0.224\\ 0.094\\ 0.084\\ 0.142\\ 0.159\\ 0.197\\ 0.209\\ 0.087\\ 0.060\\ 0.052 \end{array}$	0.039 0.049 0.059 0.048 0.010 0.008 0.060 0.077 0.024 0.024 0.024 0.012 0.006 0.009
USM6-4A USM6-4B	12/20/86-01/12/87 12/20/86-01/12/87	0.447 0.425	375 356	0.945 0.969	0.328 0.305	0.031 0.025

Table 4. New Technology US Manufactured Particleboards

Note:

USM1 through USM7 indicates US manufacturers 1 through 7 The number after the dash indicates the product sample The final letter (A,B or C) indicates the specimen (usually two were provided for each product.

Table 5. Regular US Manufactured	MDF	2
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Board #	Date	intercept	cutoff	R²	ser ₁₀₀	Std. error
		mg/m²•h	ppb		mg/m²•h	mg/m²•h
MDF1 MDF2	06/01/87-06/15/87 06/01/87-06/15/87	1.735 1.137	934 796	0.995 0.984	1.549 0.994	0.038
MDF3	05/15/87-05/29/87	1.311	970	0.967	1.176	0.078
MDF4	06/01/87-06/15/87	1.293	1371	0.998	1.199	0.055
MDF5	05/15/87-05/29/87	1.435	1782	0.984	1.354	0.062

Note:

MDF1 through MDF5 indicated medium density fiber board specimens 1 through 5 all of the same US manufacturer

Date	intercept	cutoff	R²	ser ₁₀₀	Std. error
	mg/m²•h	ppb		mg/m²∙h	mg/m²•h
	Untreated				
10/04/85-10/25/85 07/20/85-07/25/85 7/20/85-7/24/85	0.211 0.241 0.208 0.201	400 415 329 285	0.420 0.727 0.913	0.158 0.183 0.145 0.130	0.036 0.025 0.020
	Lacquer-trea	ted			
10/04/85-10/25/85 10/07/85-10/25/85	0.152 0.109 0.212	356 463 287	0.520 0.781 0.781	0.109 0.085 0.138	0.024 0.010 0.021
Po	olyurethane-ti	reated			
10/07/85-10/9/85	0.025	1218		0.028	
	Latex-treate	ed			
10/04/85-10/26/85 10/04/85-10/25/85	0.215 0.216 0.223	331 294 342	0.75 0.741 0.885	0.150 0.142 0.158	0.020 0.023 0.014
Particle Boards R	eceived from	Ball State	e Universi	ty	
Ţ	Unknown Coa	ating			
03/30/87-04/18/87	0.035	121	0.710	0.006	0.009
	Untreated				
03/30/87-04/18/87	0.310	337	0.979	0.218	0.013
	Date 10/04/85-10/25/85 07/20/85-07/25/85 7/20/85-7/24/85 10/04/85-10/25/85 Particle Boards R 03/30/87-04/18/87	Date intercept mg/m²+h Untreated 10/04/85-10/25/85 0.241 07/20/85-07/25/85 0.208 7/20/85-7/24/85 0.201 Lacquer-treat 0.152 10/04/85-10/25/85 0.109 10/04/85-10/25/85 0.109 10/07/85-10/25/85 0.212 Polyurethane-tr 10/07/85-10/9/85 10/04/85-10/26/85 0.215 10/04/85-10/26/85 0.216 10/04/85-10/25/85 0.216 10/04/85-10/26/85 0.216 10/04/85-10/26/85 0.216 03/30/87-04/18/87 0.035 03/30/87-04/18/87 0.310	Date intercept cutoff mg/m ² -h ppb Untreated 0.211 400 0.7/20/85-07/25/85 0.241 415 07/20/85-07/25/85 0.208 329 7/20/85-7/24/85 0.201 285 10/04/85-10/25/85 0.201 285 10/04/85-10/25/85 0.152 356 10/07/85-10/25/85 0.212 287 10/07/85-10/25/85 0.212 287 10/07/85-10/25/85 0.215 331 10/07/85-10/25/85 0.215 331 10/04/85-10/26/85 0.215 331 10/04/85-10/26/85 0.216 294 10/04/85-10/25/85 0.216 294 10/04/85-10/25/85 0.216 294 10/04/85-10/25/85 0.216 294 10/04/85-10/25/85 0.216 294 03/30/87-04/18/87 0.035 121 Untreated 03/30/87-04/18/87 0.310 337	Dateinterceptcutoff \mathbb{R}^2 mg/m2+hppbuntreated10/04/85-10/25/850.2114000.42007/20/85-07/25/850.2414150.72707/20/85-07/25/850.2083290.9137/20/85-7/24/850.2012850.91310/04/85-10/25/850.1523560.52010/04/85-10/25/850.1094630.78110/07/85-10/25/850.2122870.781Polyurethane-treated10/07/85-10/9/850.0251218Latex-treated10/04/85-10/26/850.21629410/04/85-10/25/850.2162940.7410.750.2233420.8850.2233420.885Unknown Coating03/30/87-04/18/870.31033703/30/87-04/18/870.31033703/30/87-04/18/870.31033703/30/87-04/18/870.310337	Date intercept cutoff R² ser,100 mg/m²+h ppb mg/m²+h ppb mg/m²+h 10/04/85-10/25/85 0.211 400 0.420 0.158 07/20/85-07/25/85 0.241 415 0.727 0.183 07/20/85-07/25/85 0.208 329 0.913 0.145 7/20/85-7/24/85 0.201 285 0.130 0.130 Lacquer-treated 10/04/85-10/25/85 0.152 356 0.520 0.109 10/04/85-10/25/85 0.122 287 0.781 0.085 10/07/85-10/25/85 0.025 1218 0.028 Latex-treated 10/04/85-10/26/85 0.215 331 0.75 0.150 10/04/85-10/26/85 0.216 294 0.741 0.142 10/04/85-10/25/85 0.216 294 0.741 0.142 10/04/85-10/25/85 0.216 294 0.741 0.142 03/30/87-04/18/87 0.035 121 0.710

Table 6. Emissions from Underlayment in Coating Experiment

Note: CU1 through C8 indicate underlayment boards used in coating experiment.

Table 7. Emissions from Industrial Particle Board

Untreated

Board #	Date	intercept	cutoff	R²	ser ₁₀₀	Std. error
		mg/m²•h	ppb		mg/m²•h	mg/m²•h
all untreated IPB1 IPB2 IPB3 IPB4	07/18/85-07/26/85 07/15/85-07/26/85 07/29/85-08/12/85 07/30/85-08/12/85	0.302 0.370 0.269 0.399 0.196	741 724 703 506 1312	0.490 0.784 0.838 0.934 0.491	0.261 0.319 0.231 0.320 0.181	0.063 0.049 0.026 0.030 0.039
		Lacquer-trea	ated			
IPB3	08/28/85-09/10/85	0.166 /	583	0.788	0.138	0.016
	P	olyurethane-t	reated			
IPB2	10/04/85-10/16/85	0.440	571	0.898	0.363	0.038
		Latex-treat	ed			
IPB4	08/29/85-09/10/85	0.471	574	0.758	0.389	0.059

Note: IPB1 through 4 indicate industrial particle boards 1 through 4 used in coating experiment.

Board #	Date	intercept	cutoff	R²	$ser_{1\infty}$	Std. error
LMDF-1A LMDF-1B LMDF-1C LMDF-1D LMDF-1E LMDF-1F LMDF-2A LMDF-2B	07/30/85-08/12/85 07/30/85-08/12/85 09/14/85-09/25/85 07/31/85-08/12/85 08/01/85-08/12/85 07/29/85-08/12/85 04/08/86-05/13/86	mg/m ² •h 0.464 0.476 0.640 0.695 0.701 0.748 0.742 0.735	ppb 1296 1012 590 1059 1013 926 947 840	0.572 0.953 0.968 0.808 0.688 0.769 0.666 0.996	mg/m→h 0.429 0.429 0.532 0.629 0.631 0.668 0.664 0.647	mg/m ² h 0.068 0.027 0.048 0.084 0.100 0.114 0.205 0.016
		Lacquer-treat	ed			
LMDF-1D	08/28/85-09/10/85	0.163	723	0.600	0.141	0.021
	Ι	Polyurethane-tr	eated			
LMDF-1B LMDF-1E	08/26/85-09/10/85 08/30/85-09/10/85	0.100 0.090	541 1576	0.879 0.038	0.081 0.084	0.0 06 0.0 10
		Latex-treate	d			
LMDF-1F	09/12/85-09/22/85	0.717	644	0.994	0.605	

Table 8. Emissions from Low-Emitting Medium Density Fiberboard

Note:

LMDF indicates low emitting medium density fiber board The number after the dash indicates the US manufacturer The final letter indicates the specimen

Board #	Date	intercept	cutoff	R²	ser ₁₀₀	Std. error
		mg/m²•h	ррb		mg∕m²•h	mg/m²•h
Sweden-1A Sweden-1B Norway-1A Norway-1B Norway-2A Norway-2B France-1A France-1B Belgium-1A Belgium-1B Belgium-2A	05/27/86-07/11/86 05/27/86-08/10/86 03/19/86-04/07/86 03/19/86-04/07/86 03/19/86-04/07/86 03/19/86-04/07/86 03/19/86-04/07/86 03/19/86-04/07/86 03/04/87-03/22/87 03/04/87-03/22/87	0.120 0.067 0.406 0.224 0.656 0.496 0.110 0.070 0.408 0.378 0.136	124 426 227 295 317 205 240 122 132 142 125	0.339 0.052 0.802 0.533 0.907 0.615 0.363 0.520 0.967 0.993 0.987	0.023 0.051 0.227 0.148 0.449 0.225 0.064 0.012 0.098 0.112 0.027	0.056 0.037 0.047 0.064 0.066 0.101 0.024 0.015 0.023 0.010 0.005
Belgium-2B	03/04/87-03/22/87	0.150	110	0.971	0.014	0.009

Table 9. Emissions from Foreign Boards

 \mathbf{x}_{i}

Table 10. Summary of Emission Rate Reduction from Coatings

Underlayment

	Ser ₁₀₀	Cutoff	Percent Untreated Ser₁∞
	mg/m²•h	ppb	
Untreated Lacquer Polyurethane Latex	0.158 0.109 0.028 0.150	400 356 400	69% 18% 95%

Industrial Underlayment

	Ser₁∞	Cutoff	Percent Untreated Ser ₁₀₀		
	mg/m²∙h	ppb			
Untreated	0.261	741			
Lacquer	0.138	583	53%		
Polyurethane	0.363	571	140%		
Latex	0.389	574	150%		

Low Emitting Medium Density Fiber Board

	Ser ₁₀₀	Cutoff	Percent Untreated Ser₁∞
	mg/m²•h	ppb	
Untreated LMDF	0.524	981	40% (of regular)
Lacquer	0.141	981	26% (of untreated LMDF)
Polyurethane	0.085	538	6% (of untreated LMDF)
Latex	0.605	644	90% (of untreated LMDF)

		P	redicted	НСНС	Conce	ntration	s (ppb)				
Air Change Rate	0	0.1	0.2	0.3	0.4	0.5	0.6	0.7	0.8	0.9	1.0
Board #											
USM1-1A	334	253	203	170	146	128	114	103	94	86	79
USM1-1B	350	259	206	171	146	127	113	101	92	84	78
USM2-1B	764	450	319	247	202	170	147	130	116	105	96
USM2-1B	848	388	252	186	148	122	105	91	81	73	66
USM3-1A	973	379	235	170	134	110	93	81	72	64	58
USM3-1B	597	306	205	155	124	104	89	78	69	62	57
USM3-2A	342	249	196	162	138	120	106	95	86	79	72
USM3-3A	391	234	167	129	106	89	78	68	61	55	51
USM3-3B	347	257	204	169	145	126	112	101	91	84	77
USM4-1A	634	328	221	167	134	112	96	84	75	67	61
USM4-1B	576	318	220	168	136	114	98	86	77	70	63
USM5-1A	431	317	251	207	177	154	137	123	111	102	94
USM5-1B	226	169	135	112	96	84	74	67	61	56	51
USM2-2A	386	229	163	127	103	87	76	67	60	54	49
USM2-2B	403	248	179	140	115	98	85	75	67	61	56
USM2-3A	852	544	400	316	261	222	194	172	154	140	128
USM2-3B	764	479	349	274	226	192	167	148	133	120	110
USM6-1A	180	146	122	106	93	83	75	68	63	58	54
USM6-1B	185	145	119	101	87	77	69	63	57	53	49
USM6-2A	383	243	177	140	115	98	86	76	68	62	56
USM6-2B	487	291	208	161	132	112	97	85	76	69	63
USM6-3A	295	232	191	162	141	125	112	101	93	85	79
USM6-3B	365	270	215	178	152	133	118	106	96	88	81
USM7-1A	312	187	133	103	85	72	62	55	49	44	40
USM7-1B	208	139	105	84	70	60	52	47	42	38	35
USM7-1C	215	133	97	76	62	53	46	41	36	33	30
USM6-4A	375	304	256	221	195	174	157	143	131	122	113
USM6-4b	356	289	243	210	185	165	149	136	125	116	107

Table A.1 Predicted Formaldehyde Levels at Various Air Change Rates in a House with Complete Underlayment Flooring Using New Technology US Products

Table A.2 Predicted Formaldehyde Levels at Various Air Change Rates in a House with Complete Underlayment Flooring Using Foreign Products

Predicted HCHO Concentrations (ppb)

Air											
Change Rate	0	0.1	0.2	0.3	0.4	0.5	0.6	0.7	0.8	0.9	1.0
Sweden-1A Sweden-1B Norway-1B Norway-2A Norway-2B France-1A France-2B Belgium-1A Belgium-1B Belgium-2A Belgium-2B	124 426 227 295 317 205 240 122 132 142 125 110	97 155 197 216 280 184 150 82 121 129 100 91	79 95 174 171 250 167 109 62 112 118 83 78	67 68 155 141 226 153 86 50 104 108 71 68	58 53 140 120 207 141 70 42 97 100 62 61	51 44 128 105 190 131 60 36 91 94 55 55	46 37 118 93 176 122 52 31 86 88 49 50	41 32 109 83 164 114 46 28 81 82 45 46	38 28 102 76 153 107 41 25 77 78 41 42	35 25 95 69 144 101 37 23 73 73 38 39	32 23 89 64 136 96 34 21 70 70 35 36



Figure 1. Emission Rates of Untreated Underlayment for Coating Experiment



Figure 2. Emission Rates of Polyurethane Coated Underlayment



Figure 3. Emission Rates of Lacquer Treated Underlayment



Figure 4. Emission Rates of Latex Treated Underlayment



Figure 5. Emission Rates of Untreated Industrial Particle Board



Figure 6. Emission Rates of Polyurethane Treated Industrial Underlayment



Figure 7. Emission Rates of Lacquer Treated Industrial Underlayment



Figure 8. Emission Rates of Latex Treated Industrial Underlayment



Figure 9. Emission Rates of Untreated Low Emitting MDF



Figure 10. Emission Rates of Untreated Low Emitting MDF



Figure 11. Emission Rates of Lacquer Treated Low Emitting MDF



Figure 12. Emission Rates of Latex Treated Low Emitting MDF



Figure 13. Examples of US Particle Boards Using Low Fuming UF Resins and a Scavenger



Figure 14. Examples of US Particle Boards Using Low Furning UF Resins



Figure 15. Emission Rates from Swedish Boards



Figure 16. Emission Rates from Norwegian Manufacture #1



Figure 17. Emission Rates from Norwegian Manufacture #2



Figure 18. Emission Rates from Belgium Manufacture #1



Figure 19. Emission Rates from Belgium Manufacture #2



Figure 20. Emission Rates from France Manufactured Boards







Figure 22. Predicted HCHO Levels from Coated Underlayment







Figure 24. Predicted HCHO Levels from Industrial Particle Boards



Figure 25. Predicted Effect of Temperature and Humidity on HCHO Levels



Figure 26. Predicted HCHO Levels From Coated and Uncoated Ball State Boards



Figure 27. Predicted HCHO Levels From Belgium Manufacturer # 1.



Predicted HCHO Levels

Figure 28. Predicted HCHO Levels From Belgium Manufacturer # 2.



Figure 29. Predicted HCHO Levels from Norweign Manufacturer # 1



Figure 30. Predicted HCHO Levels from Norweign Manufacturer # 2



Figure 31. Predicted HCHO Levels from French Boards



Predicted HCHO Levels

Figure 32. Predicted HCHO Levels from Swedish Boards